TOSHIBA Rectifier Silicon Diffused Type

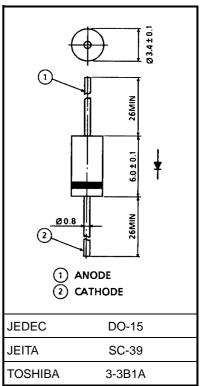
# 1S1832

High Speed Rectifier Applications (fast recovery)

- Average Forward Current:  $I_{F(AV)} = 0.7 \text{ A} (Ta = 50^{\circ}\text{C})$
- Repetitive Peak Reverse Voltage: V<sub>RRM</sub> = 1800 V
- Reverse Recovery Time:  $t_{rr} = 6.0 \ \mu s$
- Plastic Mold Type.

### Maximum Ratings (Ta = 25°C)

Characteristics	Symbol	Rating	Unit	
Repetitive peak reverse voltage	V <sub>RRM</sub>	1800	V	
Reverse voltage (DC)	V <sub>R</sub>	V <sub>R</sub> 1500		
Average forward current (Ta = 50°C)	I <sub>F (AV)</sub>	0.7	А	
Peak one cycle surge forward current (non repetitive)	I <sub>FSM</sub>	60 (50 Hz)	A	
		66 (60 Hz)		
Junction temperature	Tj	-40 to 125	°C	
Storage temperature range	T <sub>stg</sub>	-40 to 125	°C	



Weight: 0.42 g (typ.)

### Electrical Characteristics (Ta = 25°C)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Peak forward voltage	V <sub>FM</sub>	I <sub>FM</sub> = 1.5 A	_	_	2.0	V
Repetitive peak reverse current	I <sub>RRM (1)</sub>	V <sub>RRM</sub> = 1500 V	_	_	10	μA
	I <sub>RRM (2)</sub>	$V_{RRM} = 1500 \text{ V}, \text{ T}_{j} = 125^{\circ}\text{C}$	_	_	400	
Reverse recovery time	t <sub>rr</sub>	$I_F = 20 \text{ mA}, I_R = 1 \text{ mA}$	_	_	6.0	μS

Note 1: Lead diameter not controlled in this zone to allow for flash, lead finish build-up, and minor irregularities other than slugs.

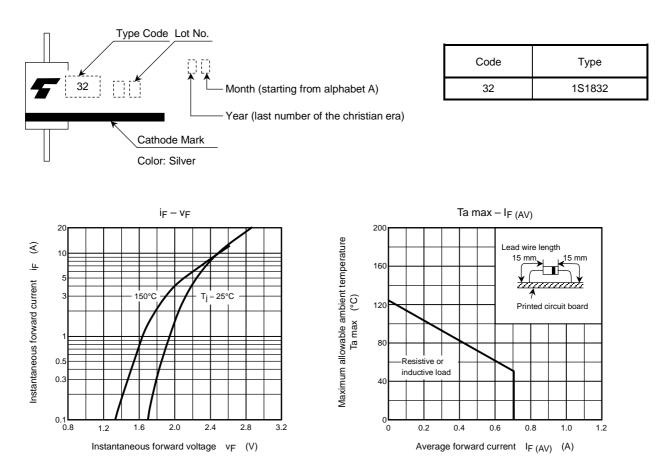
Note 2: Soldering: 5 mm is the minimum to be kept between case and soldering part.

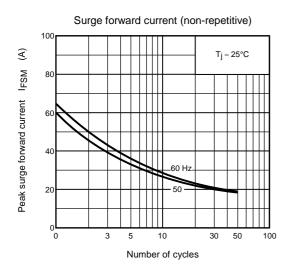
Note 3: Lead bending: 5 mm is the minimum to be kept from the case when bend the lead wire.

Unit: mm

## **TOSHIBA**

### Marking





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